

SENSITIVE SCRs

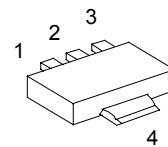
DESCRIPTION

The X0202/A SCR series is suitable for all applications where the available gate current is limited, such as ground fault circuit interruptors, overvoltage crowbar protection in low power supplies, capacitive ignition circuit,.....

FEATURES:

* $I_{T(RMS)}$: 1.25A

* V_{DRM}/V_{RRM} : 600/800V



SOT-223

1: GATE 2,4: ANODE 3: CATHODE

ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETERS	SYMBOL	RATINGS	UNIT
Peak Repetitive Forward and Reverse Blocking Voltage ($T_J=110^{\circ}\text{C}$, $R_{GK}=1\text{k}\Omega$)	V_{DRM} , V_{RRM}	600 800	V
RMS On-State Current (Ttab=95°C) 180°C conduction angle	$I_{T(RMS)}$	1.25	A
Average On-State Current (Ttab=95°C) 180°C conduction angle	$I_{T(AV)}$	0.8	A
Non Repetitive Surge Peak on-state Current (tp=8.3ms $T_J=25^{\circ}\text{C}$)	I_{TSM}	25	A
Non Repetitive Surge Peak on-state Current (tp=10ms $T_J=25^{\circ}\text{C}$)	I_{TSM}	22.5	A
I t Value for fusing (tp=10ms $T_J=25^{\circ}\text{C}$)	I t	2.5	A ² S
Critical Rate Of Rise Of On-state Current $I_G=2 \cdot I_{GT}$, tr ≤ 100ns, f=60Hz, $T_J=125^{\circ}\text{C}$	dI/dt	50	A/μs
Peak Gate Current (p=20μs $T_J=125^{\circ}\text{C}$)	I_{GM}	1.2	A
Average Gate Power Dissipation ($T_J=125^{\circ}\text{C}$)	$P_{G(AV)}$	0.2	W
Storage Junction Temperature Range	T_{stg}	-40~150	°C
Operating Junction Temperature Range	T_J	-40~125	°C

ELECTRICAL CHARACTERISTICS (T_j=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Peak Forward or Reverse Blocking Current T _j =25°C T _j =125°C	I _{DRM} , I _{RRM}	V _{DRM} =V _{RRM} , R _{GK} =1k Ω			5 500	μ A μ A
Peak Forward On-State Voltage	V _{TM}	I _{TM} = 2.5A, t _p =380μs			1.45	V
Gate Trigger Current	I _{GT}	V _D =12V, R _L =140 Ω			200	μ A
Gate Trigger Voltage	V _{GT}	V _D =12V, R _L =140 Ω			0.8	V
Gate Non-Trigger Voltage	V _{GD}	V _D =V _{DRM} , R _L =3.3k Ω, R _{GK} =1k Ω, (T _j =125°C)	0.1			V
Holding Current	I _H	I _T =50mA, R _{GK} =1k Ω			5	mA
Latch Current	I _L	I _G =1mA, R _{GK} =1k Ω			6	mA
Critical Rate of Rise of Off-State Voltage	dv/dt	V _D =67%V _{DRM} , R _{GK} =1k Ω, (T _j =110°C)	10			V/μs
Peak Reversed Gate Voltage	V _{RG}	I _{RG} =10μ A	8			V
Threshold Voltage	V _{TO}	(T _j =125°C)			0.9	V
Dynamic Resistance	R _d	(T _j =125°C)			200	m Ω

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th(j-t)}	Junction to tab	25	°C/W
R _{th(j-a)}	Junction to ambient (S=5cm)	60	°C/W

S=Copper surface under tab

TYPICAL CHARACTERISTICS CURVE

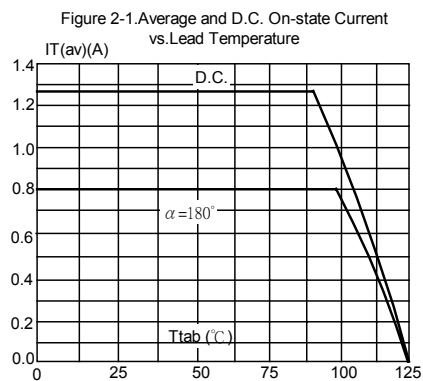
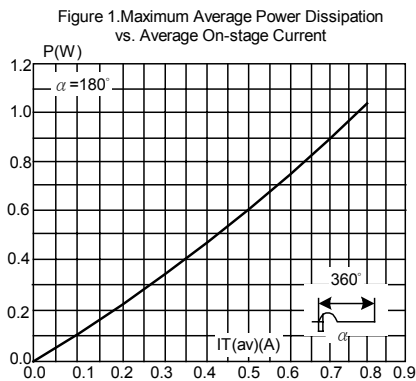


Figure 2-2.Average and D.C. On-state Current
vs.Ambient Temperature(Device Mounted On
FR4 with Recommended Pad Layout)

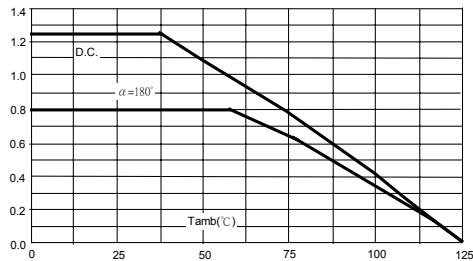


Figure 4.Relative Variation of Gate Trigger
Current,Holding Current and Latching Current
Versus Junction Temperature (typical values).

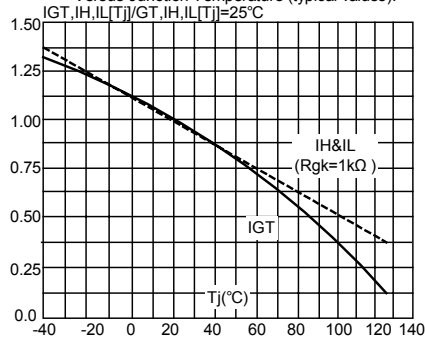


Figure 6.Relative Variation of dV/dt immunity
vs. Gate-Cathode Resistance (typical values).

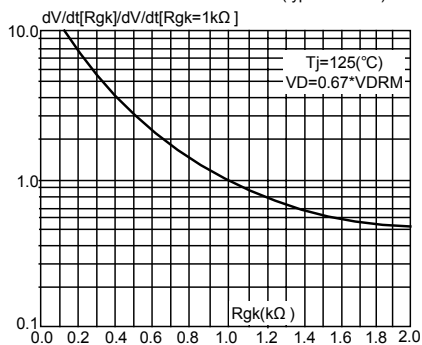


Figure 3. Relative Variation of Thermal
Impedance Junction to Ambient
vs.Pulse Duration

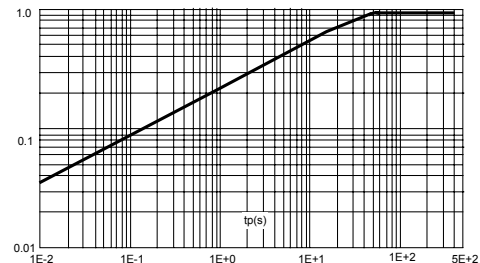


Figure 5.Relative Variation of Holding Current
vs. Gate-cathode Resistance (typical values).

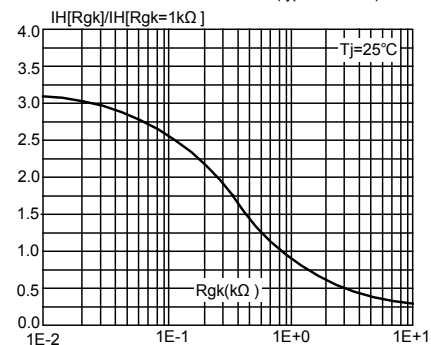


Figure 7.Relative Variation of dV/dt Immunity
vs Gate-cathode Capacitance (typical values).

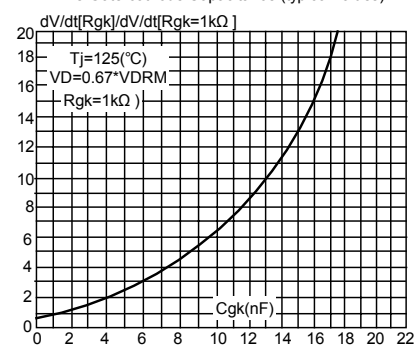


Figure 8. Surge Peak On-state Current vs. Number of Cycles.

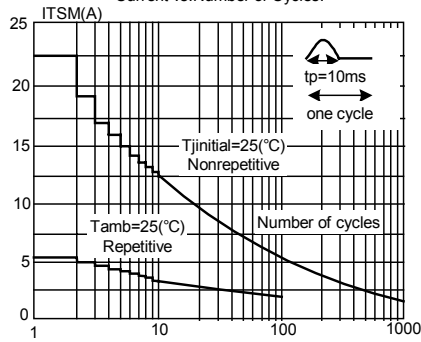


Figure 9. Non-repetitive Surge Peak on-state Current for a Sinusoidal pulse with width $t_p < 10\text{ms}$, and Corresponding Value of I_t

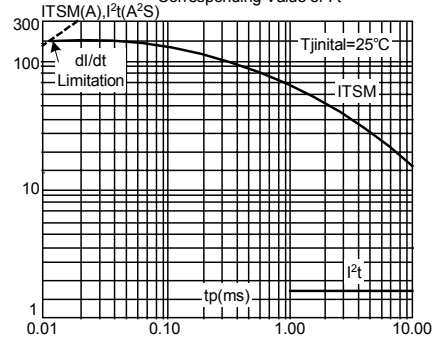


Figure 10. On-state Characteristics (maximum values)

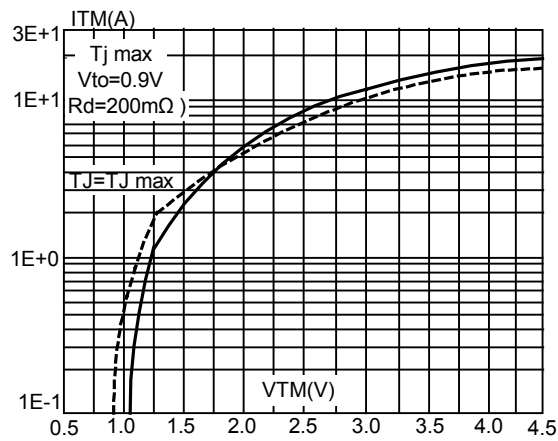
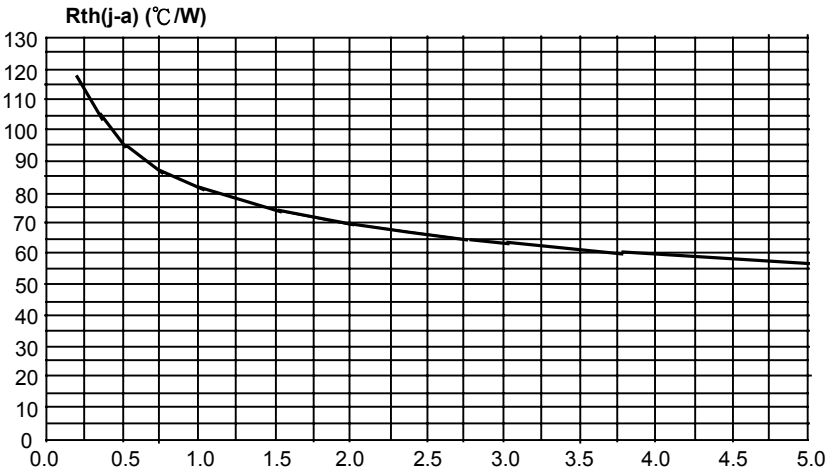


Figure 11. Thermal resistance junction to ambient versus
copper surface under tab(Epoxy printed circuit board
FR4,copper thickness: 35 μ m)



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